TOSHIBA

Unit in mm

FIBER OPTIC RECEIVING MODULE

T O R X 1 9 3 K

FIBER OPTIC RECEIVING MODULE FOR DIGITAL AUDIO EQUIPMENT AND NAVIGATION SYSTEM

- Conform to EIAJ Standard CP-1201 (For Digital Audio Interfaces including Fiber Optic inter-connections).
- TTL Interface
- ATC (Automatic Threshold Control) circuit is used for stabilized output at a wide range of optical power level.

13.2 ± 0.3 14±0.3 10.2 ± 0.2 10 ± 0.3 $\phi 2.4 \pm 0.1$ 2.5 13.2 0.5 ± 0.1 $\phi 0.45 \pm 0.1$ 0.25 ± 0.1 10.4 Pin connection Output GND (Degital) Vcc GND (Analogue) 5. Case 6. Case

1. Maximum Ratings (Ta = 25°C)

ITEM	SYMBOL	RATING	UNIT
Storage Temperature	$\mathrm{T_{stg}}$	-40 to 85	$^{\circ}\mathrm{C}$
Operating Temperature	$T_{ m opr}$	-40 to 85	°C
Supply Voltage	v_{CC}	-0.5 to 7	V
Low Level Output Current	$I_{ m OL}$	20	mA
High Level Output Current	I_{OH}	-1	mA
Soldering Temperature	${ m T_{sol}}$	260 (¹)	$^{\circ}\mathrm{C}$

Note (¹) Soldering time≤10 seconds (More than 1mm apart from package).

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The information contained herein is subject to change without notice.

2. Recommended Operating Conditions

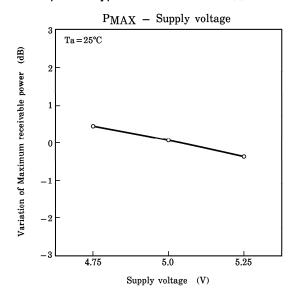
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	v_{CC}	4.75	5.0	5.25	V
High Level Output Current	$I_{ m OH}$	_		-150	μ A
Low Level Output Current	$IO\Gamma$	_		1.6	mA

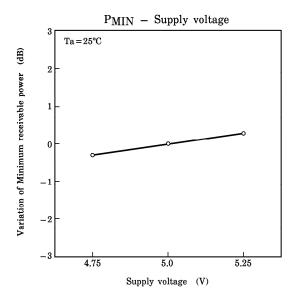
3. Electrical and Optical Characteristics ($Ta = 25^{\circ}C$, $V_{CC} = 5V$)

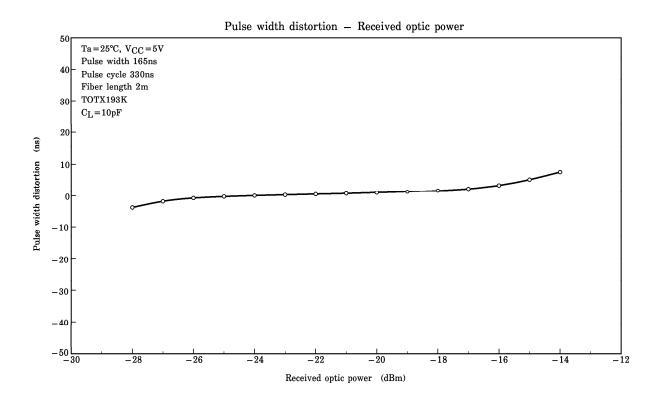
	1					
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Data Rate		NRZ Code (2)	DC	_	6	Mb/s
Transmission Distance		Using APF (3)	0.2	_	10	m
Pulse Width Distortion (4)	Δtw	Pulse width 165ns Pulse cycle 330ns C _L =10pF, Using TOTX193K	-25		25	ns
Maximum Receivable Power (⁵)	PMAX	6Mb/s, Using APF	-14.5	_	_	dBm
Minimum Receivable Power (⁵)	P _{MIN}	6Mb/s, Using APF	_	_	-27	dBm
Current Consumption	I_{CC}		_	22	40	mA
High Level Output Voltage	v_{OH}		2.7	_	_	V
Low Level Output Voltage	$v_{ m OL}$		_	_	0.4	V

- (2) For data rate>3Mb/s, the duty factor must be such as kept 25 to 75%. High level output when optical flux is received. Low level output when optical flux is not received.
- (3) All Plastic Fiber $(980/1000 \mu m)$
- (4) Between input of a fiber optic transmitting module TOTX193K and output of TORX193K.
- (5) BER $\leq 10^{-9}$, Valued by peak.

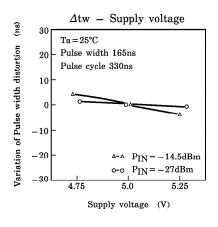
4. Example of Typical Characteristics (6)

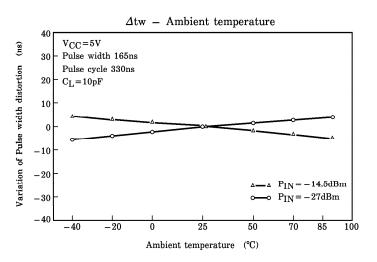


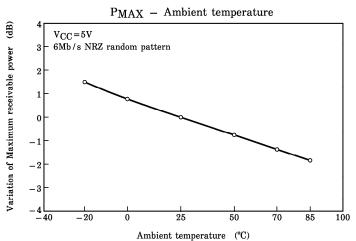


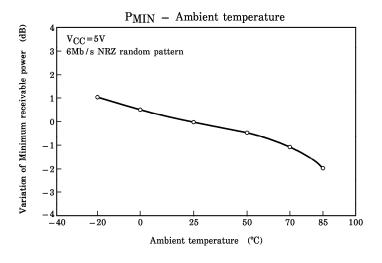


(6) There give characteristic examples, and its values are not guaranteed.



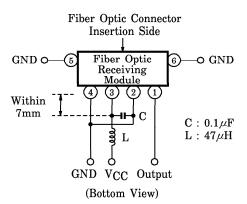






(6) There give characteristic examples, and its values are not guaranteed.

5. Connection Method



6. Precaution on Use

(1) Maximum Rating

The maximum ratings are the limit values which must not be exceeded when using the device. Any one of the rating must not be exceeded. If The maximum rating is exceeded, the characteristics may not be recovered. In some extreme cases, the device may be permanently damage.

(2) Soldering

Optical modules use semiconductor devices internally. However, in principle, optical modules are optical components. At soldering, take care that flux dose not contact the emitting surface or detecting surface. Also take care at flux removal after soldering.

Some optical modules come with protective cap. The protective cap is used to avoid malfunction when the optical module is not in use. Not that it is not dust or waterproof.

As mentioned before, optical modules are optical component. Thus, in principle, soldering where there may be flux residue or flux removal after soldering is not recommended. Toshiba recommends that soldering be performed without the optical module mounted on the board. Then, after the board is cleaned, solder the optical module manually. Do not perform any further cleaning.

If the optical module cannot be soldered manually, use non-halogen (chlorine-free) flux and make sure, without cleaning, there is no residue such as chlorine. This is one of the ways to eliminate the effects of flux. In such a case, check the reliability.

(3) Noise Resistance

Where the fiber optic receiving module case uses conductive resin, shield by connecting the reinforcing pin at a front end of the module to GND. When using this optical module, connect the pin to SIGNAL-GND.

Where the fiber optic receiving module case has a resistance of several tens of ohms, take care that the case does not contact power line of other circuits.

It is believed that the use of optical transfer devices improve the noise resistance. In principle, optical fiber is not affected by noise. However, especially receiving module which handle signals whose level is extremely small, are comparatively more susceptible to noise.

TOSLINK improves noise resistance using a conductive case. However, the current of the signal output from the photodiode of the optic receiving module is extremely small. Thus, depending on the usage environment, shielding the case is not sufficient for noise resistance. When using TOSLINK, Toshiba recommends that you test using the actual device and check the noise resistance.

Use a simple noise filter on the TOSLINK fiber optic receiving module power line. If the ripple in power supply used is high, further reinforce the filter.

When locating the optical module in an area susceptible to radiated noise, increase shielding by covering the optical module and the power line filter using a metallic cover.

(4) Vibration and Shock

This module is resin-molded construction with wire fixed by resin. This structure is relatively sound against vibration or shock, In actual equipment, there are some cases where vibration, shock, and stress is applied to soldered parts or connected parts, resultingin line cut. Attention must be paid to the design of the mechanism for applications which are subject to large amounts of vibration.

(5) Fixing Fiber Optical Receiving Module

Solder the fixed pin (pins 5 and 6) of fiber optic receiving module TORX193K to the printed circuit board to fix the module to the board.

(6) Panel attachment

TORX193K provides hole for panel attachment. Please be sure to attach it to panel.

(7) Shielding and Wiring Pattern of Fiber Optic Receiving Modules

To shield, connect the fixed pins (pins 5 and 6) of fiber optic transceiving module TORX193K to the GND.

Where the fiber optic receiving module uses conductive resin, be careful that the case does not touch wiring (including land).

To improve noise resistance, shield the optical module and the power line filter using a metallic cover.

(8) Solvent

When using solvent for flux removal, do not use a high acid or high alkali solvent. Be careful not to pour solvent in the optical connector ports. If solvent is inadvertently poured there, clean with cotton tips.

(9) Protective Cap

When the fiber optic receiving module TORX193K is not in use, use the protective cap.

(10) Supply Voltage

Use the supply voltage within the Typ. operating condition ($V_{CC}=5\pm0.25V$). Make sure that supply voltage does not exceed the maximum rating value of 7V, even instantaneously.

(11) Interface

TORX193K has a TTL interface. It can be interfaced with C-MOS IC that has compatibility with TTL level.

(12) Output

When the receiver output is at low level and connected to the power supply, or when the output is at high level and connected to GND, the internal IC may be destroyed.

(13) Soldering Condition

Solder at 260°C or less within three seconds.

(14) Precaution on Waste

When discarding devices and packing materials, follow procedures stipulated by local regulations in order to protect the environment against contamination.

(15) Precaution on Use

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